

#### **Vishay Telefunken**

# 2.7 V to 5.5 V Serial Infrared Transceiver Module Family (SIR, 115.2 kbit/s)



### Description

The TFDU4100, TFDS4500, and TFDT4500 are a family of low-power infrared transceiver modules compliant to the IrDA standard for serial infrared (SIR) data communication, supporting IrDA speeds up to 115.2 kbit/s. Integrated within the transceiver modules are a photo PIN diode, infrared emitter (IRED), and a low-power analog control IC to provide a total front-end solution in a single package. Telefunken's SIR transceivers are available in three package options, including our BabyFace package (TFDU4100), the once smallest SIR transceiver

#### **Features**

- Compliant to the latest IrDA physical layer standard (Up to 115.2 kbit/s)
- 2.7 to 5.5 V Wide Operating Voltage Range
- Low–Power Consumption (1.3 mA Supply Current)
- Power Sleep Mode Through V<sub>CC1</sub>/SD Pin (5 nA Sleep Current)
- Long Range (Up to 3.0 m at 115.2 k/bit/s)
  - Three Surface Mount Package Options
    - Universal  $(9.7 \times 4.7 \times 4.0 \text{ mm})$
    - Side View  $(13.0 \times 5.95 \times 5.3 \text{ mm})$
    - Top View (13.0  $\times$  7.6  $\times$  5.95 mm)

### Applications

- Notebook Computers, Desktop PCs, Palmtop Computers (Win CE, Palm PC), PDAs
- Digital Still and Video Cameras
- Printers, Fax Machines, Photocopiers, Screen Projectors

### **Package Options**

TFDU4100 Baby Face (Universal)



interfacing with a wide variety of I/O chips which perform the pulse–width modulation/demodulation function, including Telefunken's TOIM4232 and TOIM3232. At a minimum, a current–limiting resistor in series with the infrared emitter and a  $V_{CC}$  bypass capacitor are the only external components required to implement a complete solution.

available on the market. This wide selection provides

flexibility for a variety of applications and space

constraints. The transceivers are capable of directly

- BabyFace (Universal) Package Capable of Surface Mount Solderability to Side and Top View Orientation
- Directly Interfaces with Various Super I/O and Controller Devices and Telefunken's TOIM3000 and TOIM3232 I/Os
- Built–In EMI Protection No External Shielding Necessary
- Few External Components Required
- Backward Compatible to all Telefunken SIR Infrared Transceivers
- Telecommunication Products (Cellular Phones, Pagers)
- Internet TV Boxes, Video Conferencing Systems
- External Infrared Adapters (Dongles)
- Medical and Industrial Data Collection Devices

TFDS4500 Side View



TFDT4500 Top View





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### **Ordering Information**

| Part Number  | Qty / Reel | Description   |
|--------------|------------|---|
| TFDU4100-TR3 | 1000 pcs   | Oriented in carrier tape for side view surface mounting |
| TFDU4100-TT3 | 1000 pcs   | Oriented in carrier tape for top view surface mounting  |
| TFDS4500-TR3 | 750 pcs    |   |
| TFDT4500-TR3 | 750 pcs    |   |

# **Functional Block Diagram**



Figure 1. Functional Block Diagram

### **Pin Description**

| Pin Numb           | er         | Function              | Description  | I/O | Active |
|--------------------|------------|-----------------------|--|-----|--------|
| "U" and "T" Option | "S" Option |                       |  |     |        |
| 1                  | 8          | IRED Anode            | IRED anode, should be externally connected to $V_{CC2}$ through a current control resistor   |     |        |
| 2                  | 1          | IRED Cathode          | IRED cathode, internally connected to driver transistor  |     |        |
| 3                  | 7          | Txd                   | Transmit Data Input  | I   | HIGH   |
| 4                  | 2          | Rxd                   | Received Data Output, open collector.<br>No external pull–up or pull–down resistor<br>is required (20 k $\Omega$ resistor internal to de-<br>vice). Pin is inactive during transmission. | 0   | LOW    |
| 5                  | 6          | NC                    | Do not connect   |     |        |
| 6                  | 3          | V <sub>CC1</sub> / SD | Supply Voltage / Shutdown  |     |        |
| 7                  | 5          | SC                    | Sensitivity control  | I   | HIGH   |
| 8                  | 4          | GND                   | Ground   |     |        |



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# TFDU4100/TFDS4500/TFDT4500

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#### "U" Option BabyFace (Universal)



#### **"T" Option Top View**







# Absolute Maximum Ratings

Reference point Pin GND unless otherwise noted. Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.

| Parameters   | Test Conditions                                    | Symbol                 | Min.  | Тур. | Max.                  | Unit  |
|--|--|------------------------|-------|------|-----------------------|-------|
| Supply Voltage Range   | $0 V \le V_{CC2} \le 6 V$                          | V <sub>CC1</sub>       | - 0.5 |      | 6                     | V     |
|  | $0 \text{ V} \leq \text{V}_{CC1} \leq 6 \text{ V}$ | V <sub>CC2</sub>       | - 0.5 |      | 6                     | V     |
| Input Currents   | For all Pins,<br>except IRED Anode Pin             |                        |       |      | 10                    | mA    |
| Output Sink Current  |  |                        |       |      | 25                    | mA    |
| Power Dissipation  | See Derating Curve                                 | PD                     |       |      | 200                   | mW    |
| Junction Temperature   |  | TJ                     |       |      | 125                   | °C    |
| Ambient Temperature<br>Range (Operating)   |  | T <sub>amb</sub>       | -25   |      | +85                   | °C    |
| Storage Temperature<br>Range   |  | T <sub>stg</sub>       | -25   |      | +85                   | °C    |
| Soldering Temperature  | See Recommended Sol-<br>der Profile                |                        |       | 215  | 240                   | °C    |
| Average IRED Current   |  | I <sub>IRED</sub> (DC) |       |      | 100                   | mA    |
| Repetitive Pulsed IRED<br>Current  | t < 90 μs, t <sub>on</sub> < 20%                   | I <sub>IRED</sub> (RP) |       |      | 500                   | mA    |
| IRED Anode Voltage   |  | VIREDA                 | - 0.5 |      | 6                     | V     |
| Transmitter Data Input<br>Voltage  |  | V <sub>Txd</sub>       | - 0.5 |      | V <sub>CC1</sub> +0.5 | V     |
| Receiver Data Output<br>Voltage  |  | V <sub>Rxd</sub>       | - 0.5 |      | V <sub>CC1</sub> +0.5 | V     |
| Virtual Source Size  | Method:<br>(1–1/e) encircled energy                | d                      | 2.5   | 2.8  |                       | mm    |
| Maximum Intensity for<br>Class 1 Operation of<br>IEC825–1 or EN60825–1<br>(worst case IrDA SIR<br>pulse pattern *) | EN60825, 1997                                      |                        |       |      | 400                   | mW/sr |

#### \* Note:

Transmitted data: continuously transmitted "0". In normal data transfer operation "0" and "1" will be transmitted with the same probability. Therefore, for that case, about a factor of two of safety margin is included. However, for worst case thermal stress testing such data pattern are often used and for this case the 400 mW/sr value has to be taken.

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### **Electrical Characteristics**

 $T_{amb} = 25^{\circ}C$ ,  $V_{CC} = 2.7$  V to 5.5 V unless otherwise noted. Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.

| Parameters   | Test Conditions / Pins   | Symbol                               | Min.       | Тур.       | Max.       | Unit     |
|--|--|--------------------------------------|------------|------------|------------|----------|
| Transceiver  |  |                                      |            |            |            |          |
| Supply Voltage   | Receive Mode<br>Transmit Mode, $R2 = 47 \Omega$<br>(see Recommended Applica-<br>tion Circuit)          | V <sub>CC1</sub><br>V <sub>CC2</sub> | 2.7<br>2.0 |            | 5.5<br>5.5 | V<br>V   |
| Supply Current Pin V <sub>CC1</sub><br>(Receive Mode)        | V <sub>CC1</sub> = 5.5 V<br>V <sub>CC1</sub> = 2.7 V   | I <sub>CC1 (Rx)</sub>                |            | 1.3<br>1.0 | 2.5<br>1.5 | mA<br>mA |
| Supply Current Pin V <sub>CC1</sub><br>(avg) (Transmit Mode) | $I_{IRED} = 210 \text{ mA}$ (at IRED Anode Pin)<br>$V_{CC1} = 5.5 \text{ V}$ $V_{CC1} = 2.7 \text{ V}$ | I <sub>CC1 (Tx)</sub>                |            | 5.0<br>3.5 | 5.5<br>4.5 | mA<br>mA |
| Leakage Current of IR<br>Emitter, IRED Anode Pin             | $V_{CC1} = OFF$ , $T_{XD} = LOW$ ,<br>$V_{CC2} = 6 V$ , $T = 25 to 85^{\circ}C$                        | I <sub>L (IREDA)</sub>               |            | 0.005      | 0.5        | μΑ       |
| Transceiver Power On<br>Settling Time                        |  | T <sub>PON</sub>                     |            | 50         |            | μs       |

# **Optoelectronic Characteristics**

 $T_{amb} = 25^{\circ}C$ ,  $V_{CC} = 2.7$  V to 5.5 V unless otherwise noted. Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.

| Parameters                               | Test Conditions  | Symbol               | Min.                  | Тур. | Max. | Unit              |
|--|--|----------------------|-----------------------|------|------|-------------------|
| Receiver                                 |  |                      |                       |      |      |                   |
| Minimum Detection                        | BER = $10^{-8}$ (IrDA Specification)                         |                      |                       |      |      |                   |
| Threshold Irradiance                     | $\alpha = \pm 15^{\circ}$ , SIR Mode, SC = LOW               | Ee                   |                       | 20   | 35   | mW/m <sup>2</sup> |
|  | $\alpha = \pm 15^{\circ}$ , SIR Mode, SC = HIGH              | Ee                   | 6                     | 10   | 15   | mW/m <sup>2</sup> |
| Maximum Detection                        | $\alpha = \pm 90^{\circ}$ , SIR Mode, V <sub>CC1</sub> = 5 V | Ee                   | 3.3                   | 5    |      | kW/m <sup>2</sup> |
| Threshold Irradiance                     | $\alpha = \pm 90^{\circ}$ , SIR Mode, V <sub>CC1</sub> = 3 V | Ee                   | 8                     | 15   |      | kW/m <sup>2</sup> |
| Logic LOW Receiver<br>Input Irradiance   | SC = HIGH or LOW   | E <sub>e</sub>       |                       |      | 4    | mW/m <sup>2</sup> |
| Output Voltage –                         | Active, C = 15 pF, R = 2.2 k $\Omega$                        | V <sub>OL</sub>      |                       | 0.5  | 0.8  | V                 |
| Rxd                                      | Non–active, C = 15 pF, R = 2.2 k $\Omega$                    | V <sub>OH</sub>      | V <sub>CC1</sub> -0.5 |      |      | V                 |
| Output Current –<br>Rxd                  | V <sub>OL</sub> < 0.8 V                                      | I <sub>OL</sub>      |                       | 4    |      | mA                |
| Rise Time – Rxd                          | $C = 15 \text{ pF}, R = 2.2 \text{ k}\Omega$                 | t <sub>r (Rxd)</sub> | 20                    |      | 1400 | ns                |
| Fall Time – Rxd                          | $C = 15 \text{ pF}, R = 2.2 \text{ k}\Omega$                 | t <sub>f (Rxd)</sub> | 20                    |      | 200  | ns                |
| Pulse Width – Rxd<br>Output              | Input pulse width = 1.6 μs,<br>115.2 kbit/s                  | t <sub>PW</sub>      | 1.41                  |      | 8    | μs                |
| Jitter, Leading Edge<br>of Output Signal | Over a Period of 10 bit, 115.2 kbit/s                        | ti                   |                       |      | 2    | μs                |
| Latency                                  |  | tL                   |                       | 100  | 500  | μs                |



# **Optoelectronic Characteristics**

 $T_{amb} = 25^{\circ}C$ ,  $V_{CC} = 2.7$  V to 5.5 V unless otherwise noted. Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.

| Parameters   | Test Conditions   | Symbol                                  | Min. | Тур. | Max.                  | Unit  |
|--|---|---|------|------|-----------------------|-------|
| Transmitter  |   |   |      |      |                       |       |
| IRED Operating<br>Current                                      | IRED Operating Current can be<br>adjusted by Variation of R1.<br>Current Limiting Resistor is in<br>Series to IRED:<br>R1 = 14 $\Omega$ , V <sub>CC2</sub> = 5.0 V                  | I <sub>IRED</sub>                       |      | 0.2  | 0.28                  | A     |
| Logic LOW Trans-<br>mitter Input Voltage                       |   | V <sub>IL</sub> (Txd)                   | 0    |      | 0.8                   | V     |
| Logic HIGH Trans-<br>mitter Input Voltage                      |   | V <sub>IH</sub> (Txd)                   | 2.4  |      | V <sub>CC1</sub> +0.5 | V     |
| Output Radiant In-<br>tensity                                  | In Agreement with IEC825 Eye<br>Safety Limit, if<br>Current Limiting Resistor is in<br>Series to IRED:<br>R1 = 14 $\Omega$ , V <sub>CC2</sub> = 5.0 V,<br>$\alpha = \pm 15^{\circ}$ | I <sub>e</sub>                          | 45   | 140  | 200                   | mW/sr |
|  | Txd Logic LOW Level   | l <sub>e</sub>                          |      |      | 0.04                  | mW/sr |
| Angle of Half<br>Intensity                                     |   | а                                       |      | ±24  |                       | 0     |
| Peak Wavelength of<br>Emission                                 |   | λρ                                      | 880  |      | 900                   | nm    |
| Half–Width of<br>Emission Spectrum                             |   |   |      | 60   |                       | nm    |
| Optical Rise Time,<br>Fall Time                                |   | t <sub>ropt,</sub><br>t <sub>fopt</sub> |      | 200  | 600                   | ns    |
| Optical Overshoot  |   |   |      |      | 25                    | %     |
| Rising Edge Peak–<br>to-Peak Jitter of<br>Optical Output Pulse | Over a Period of 10 bits,<br>Independent of<br>Information content  |   |      |      | 0.2                   | μs    |

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#### **Recommended Circuit Diagram**

The only required components for designing an IrDA 1.2 compatible design using Telefunken SIR transceivers are a current limiting resistor to the IRED. However, depending on the entire system design and board layout, additional components may be required (see figure 3). It is recommended that the capacitors C1 and C2 are positioned as near as possible to the transceiver power supply pins. A tantalum capacitor should be used for C1, while a ceramic capacitor should be used for C2 to suppress RF noise. Also, when connecting the described circuit to the power supply, low impedance wiring should be used.



Figure 3. Recommended Application Circuit

R1 is used for controlling the current through the IR emitter. For increasing the output power of the IRED, the value of the resistor should be reduced. Similarly, to reduce the output power of the IRED, the value of the resistor should be increased. For typical values of R1 (see figures 4 and 5), e.g. for IrDA compliant operation (V<sub>CC2</sub> = 5 V ± 5%), a current control resistor of 14  $\Omega$  is recommended. The upper drive current limitation is dependent on the duty cycle and is given by the absolute maximum ratings on the data sheet and the eye safety limitations given by IEC825–1.

R2, C1 and C2 are optional and dependent on the quality of the supply voltage  $V_{CC1}$  and injected noise. An unstable power supply with dropping voltage during transmission may reduce sensitivity (and transmission range) of the transceiver.

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| Component | Recommended Value                             | Vishay Part Number   |
|-----------|---|----------------------|
| C1        | 4.7 μF, Tantalum                              | 293D 475X9 016B 2T   |
| C2        | 0.1 μF, Ceramic                               | VJ 1206 Y 104 J XXMT |
| R1        | 14 $\Omega$ , 0.25 W (recommended using       |                      |
|           | two 7 $\Omega$ , 0.125 W resistors in series) | CRCW-1206-7R00-F-RT1 |
| R2        | 47 Ω , 0.125 W                                | CRCW-1206-47R0-F-RT1 |

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The sensitivity control (SC) pin allows the minimum detection irradiance threshold of the transceiver to be lowered when set to a logic HIGH. Lowering the irradiance threshold increases the sensitivity to infrared signals and increases transmission range up to 3 meters. However, setting the Pin SC to logic HIGH also makes the transceiver more susceptable to transmission errors due to an increased sensitivity to fluorescent light disturbances. It is recommended to set the Pin SC to logic LOW or left open if the increased range is not required or if the system will be operating in bright ambient light.

The guide pins on the side-view and top-view packages are internally connected to ground but should not be connected to the system ground to avoid ground loops. They should be used for mechanical purposes only and should be left floating.

### Shutdown

The internal switch for the IRED in Telefunken SIR transceivers is designed to be operated like an open collector driver. Thus, the V<sub>cc2</sub> source can be an unregulated power supply while only a well regulated power source with a supply current of 1.3 mA connected to V<sub>CC1</sub>/SD is needed to provide power to the remainder of the transceiver circuitry in receive mode. In transmit mode, this current is slightly higher (approximately 4 mA average at 3 V supply current) and the voltage is not required to be kept as stable as in receive mode. A voltage drop of V<sub>CC1</sub> is acceptable down to about 2.0 V when buffering the voltage directly from the Pin V<sub>CC1</sub> to GND see figure 3).

This configuration minimizes the influence of high current surges from the IRED on the internal analog control circuitry of the transceiver and the application circuit. Also board space and cost savings can be achieved by eliminating the additional linear regulator normally needed for the IRED's high current requirements.

The transceiver can be very efficiently shutdown by keeping the IRED connected to the power supply  $V_{CC2}$  but switching off  $V_{CC1}/SD$ . The power source to  $V_{CC1}/SD$  can be provided directly from a microcontroller (see figure 6). In shutdown, current loss is realized only as leakage current through the current limiting resistor to the IRED (typically 5 nA). The settling time after switching  $V_{CC1}/SD$  on again is

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approximately 50  $\mu$ s. Telefunken's TOIM3232 interface circuit is designed for this shutdown feature. The V<sub>CC\_SD</sub>, S0 or S1 outputs on the TOIM3232 can be used to power the transceiver with the necessary supply current.

If the microcontroller or the microprocessor is unable to drive the supply current required by the transceiver, a low–cost SOT23 pnp transistor can be used to switch voltage on and off from the regulated power supply (see figure 7). The additional component cost is minimal and saves the system designer additional power supply costs.



Figure 7.



#### **Recommended SMD Pad Layout**

The leads of the device should be soldered in the center position of the pads.



Figure 8. TFDU4100 BabyFace (Universal)



Figure 9. TFDS4500 Side View Package



Figure 10. TFDT4500 Top View Package Note: Leads of the device should be at least 0.3 mm within the ends of the pads. Pad 1 is longer to designate Pin 1 connection to transceiver.



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### **Recommended Solder Profile**



Figure 11. Recommended Solder Profile

# **Current Derating Diagram**



Figure 12. Current Derating Diagram





# TFDU4100 – BabyFace (Universal) Package (Mechanical Dimensions)











# TFDT4500 – Top View Package (Mechanical Dimensions)





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#### **Ozone Depleting Substances Policy Statement**

It is the policy of Vishay Semiconductor GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

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